Thyristors Datasheet

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Additional Information





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Resources

Accessories

Samples

Description

Designed primarily for full-wave ac control applications, such as motor controls, heating controls and power supplies; or wherever half–wave silicon gate–controlled, solid–state devices are needed.

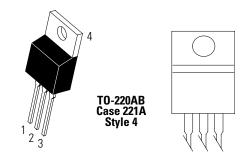
Features

- Glass Passivated Junctions and Center Gate Fire for Greater Parameter Uniformity and Stability
- Blocking Voltage to 50 Volts
- This is a Pb-Free Device
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability

Functional Diagram



Pin Out



Maximum Ratings (TJ = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = 25° to 100°C)	V _{drm} , V _{rrm}	50	V
On-State RMS Current (180° Conduction Angles; $T_c = 75$ °C)	I _{T (RMS)}	8.0	А
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, $T_c = 75^{\circ}$ C)	I	90	А
Circuit Fusing Consideration (t = 8.3 ms)	l²t	34	A ² sec
Forward Peak Gate Power (Pulse Width = 10 μ s, T _c = 70°C)	P _{GM}	5.0	W
Forward Average Gate Power (t = 8.3 ms, $T_c = 70^{\circ}$ C)	P _{G (AV)}	0.5	W
Forward Peak Gate Current (Pulse Width = 10 s, $T_c = 70^{\circ}$ C)	I _{GM}	2.0	W
Operating Junction Temperature Range	T	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the

Recommended Operating Conditions may affect device reliability. 1. V_{DBM} and V_{BBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance	Junction-to-Case (AC) Junction-to-Ambient	R _{sjc} R _{sja}	1.8 62.5	°C/W
Maximum Lead Temperature for Soldering Purpose	s, 1/8" from case for 10 seconds	T,	260	°C

Electrical Characteristics - OFF (TC = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
†Peak Repetitive Blocking Current	T_ = 25°C	I _{DRM} ,	-	-	10	μΑ
$(V_{AK} = V_{DRM} = V_{RRM}; \text{ Gate Open})$	T_ = 125°C	I	-	-	0.5	mA

Electrical Characteristics - ON (TC = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak On–State Voltage (Note 2) (I_{TM} = 16 A Peak, T_{C} = 25°C)		V _{TM}	_	-	1.83	V
Gate Trigger Current (Continuous dc)	$T_c = 25^{\circ}C$	I	_	-	25	mA
$(V_{AK} = 12 \text{ V}, \text{ R}_{L} = 100 \Omega)$	$T_c = -40^{\circ}C$	GT	-	-	40	ША
Gate Trigger Voltage (Continuous dc)	$T_c = 25^{\circ}C$	V	-	-	1.5	V
$(V_{AK} = 12 \text{ V}, \text{ R}_{L} = 100 \Omega)$	$T_c = -40^{\circ}C$	V _{gt}	-	-	2.0	v
Gate Non-Trigger Voltage (Continuous dc) $(V_{AK} = 12 \text{ V}, \text{ R}_{L} = 100 \Omega, \text{ T}_{c} = 125^{\circ}\text{C})$		V_{GD}	0.2	-	_	
Holding Current	$T_c = 25^{\circ}C$	V	-	-	30	mA
$(V_{D} = 12 \text{ V}, \text{ Gate Open}, \text{ Initiating Current} = 200 \text{ mA})$	$T_c = -40^{\circ}C$	V_{GD}	-	-	60	ША
Turn-Of f Time (V_{D} = Rated V_{DRM}) (I_{TM} = 8 A, I_{R} = 8 A)		t _q	-	30	_	μS

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate of Rise of Off-State Voltage ($V_D = 0.66 \times V_{DRM'}$ Exponential Waveform, Gate Open, $T_J = 100^{\circ}$ C)	dV/dt	-	200	-	V/µs



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Voltage Current Characteristic of SCR

Symbol	Parameter
V _{drm}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

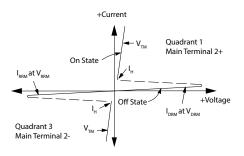


Figure 1. Current Derating (Half-Wave)

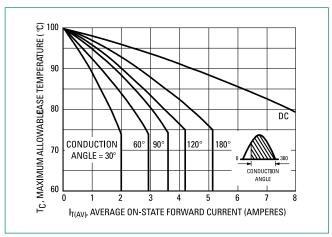


Figure 3. Maximum Power Dissipation (Half-Wave)

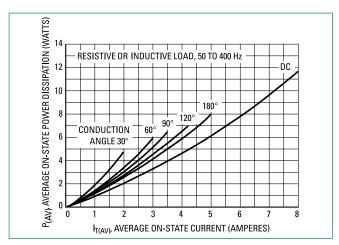
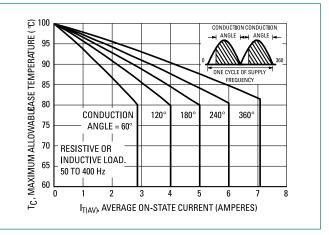
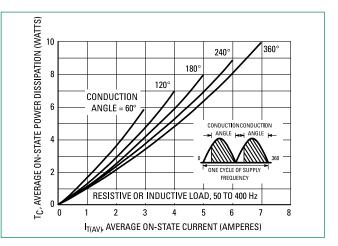


Figure 2. Current Derating (Full-Wave)

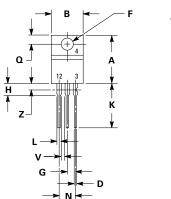


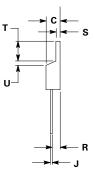




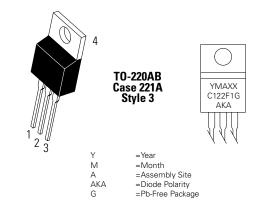
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Dimensions





Part Marking System



Dim	Inc	hes	Millin	neters
Dim	Min	Мах	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
К	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
Ν	0.195	0.205	4.95	5.21
٥	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
v	0.045	-	1.15	-
Z	-	0.080	-	2.04

Pin Assignment			
1	Cathode		
2	Anode		
3	Gate		
4	Anode		

Ordering Information

Device	Package	Shipping
C122F1G	TO-220AB (Pb-Free)	1000 Units / Box

1. Dimensioning and tolerancing per ansi y14.5m, 1982.

Controlling dimension: inch.
Dimension z defines a zone where all body and lead irregularities are allowed.

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